

PRODUCT RELIABILITY REPORT FOR

DS1845, Rev C1

Dallas Semiconductor

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Conclusion

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

DS1845, Rev C1

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

 $AfT = \exp((Ea/k)^*(1/Tu - 1/Ts)) = tu/ts$

AfT = Acceleration factor due to Temperature

tu = Time at use temperature (e.g. 55°C)

ts = Time at stress temperature (e.g. 125°C)

k = Boltzmann's Constant (8.617 x 10-5 eV/°K)

Tu = Temperature at Use (°K)

Ts = Temperature at Stress (°K)

Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

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AfV = \exp(B^*(Vs - Vu))
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AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

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Fr = X/(ts * AfV * AfT * N * 2)
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X = Chi-Sq statistical upper limit

N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 27278 FITS: 4.2

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 5.5 Volt

The reliability data follows. A the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "*" after DATE CODE denotes specific product

Device Information:

Process: E6WA-2P2M,HPVt,E2,EPROGVt,TCZ,PF ALOCOS:GOI

Passivation: Passivation w/Nov TEOS Oxide-Nitride

Die Size: 94 x 85 Number of Transistors: 25707

Interconnect: Aluminum / 1% Silicon / 0.5% Copper

Gate Oxide Thickness: 150 Å

	ELECTRICAL CHARACTERIZATION							
DESCRIPTION DATE COD		DATE COD	CONDITION	REAL	POINT	QTY	FAILS	FA#
	ESD SENSITIVITY	0549 *	EOS/ESD S5.1 HBM 500 VOLTS	1	PUL'S	3	0	
	ESD SENSITIVITY	0549 *	EOS/ESD S5.1 HBM 1000 VOLTS	1	PUL'S	3	0	
	ESD SENSITIVITY	0549 *	EOS/ESD S5.1 HBM 2000 VOLTS	1	PUL'S	3	0	
	ESD SENSITIVITY	0549 *	EOS/ESD S5.1 HBM 4000 VOLTS	1	PUL'S	3	0	
	ESD SENSITIVITY	0549 *	EOS/ESD S5.1 HBM 8000 VOLTS	1	PUL'S	3	3	No FA
	LATCH-UP	0549 *	JESD78, I-TEST 125C	2	DYS	6	0	
	LATCH-UP	0549 *	JESD78, Vsupply TEST 125C	2	DYS	6	0	
					Total:		3	

OPERATING LIFE								
DESCRIPTION	DATE COD	CONDITION	READPOINT	QTY FAILS	FA#			
HIGH TEMP OP LIFE	0443	125C, 5.5 VOLTS	1000 HRS	77 0				
HIGH TEMP OP LIFE	0507	125C, 5.5 V (PSA) & 17.0 V (PSB)	1000 HRS	45 0				
HIGH TEMP OP LIFE	0535	125C, 3.6 VOLTS	408 HRS	45 0				
HIGH TEMP OP LIFE	0539	125C, 5.5 VOLTS	1000 HRS	77 0				
HIGH TEMP OP LIFE	0549 *	125C, 5.5 VOLTS	192 HRS	77 0				
			Total:	0				

W/E ENDURANCE AND DATA RET'N								
DESCRIPTION	DATE COD	CONDITION	READ	POINT	QTY	FAILS	FA#	
WRITE CYCLE STRESS (KCYS)	0443	70 C, 5.5 VOLTS	30	KCYS	77	0		
STORAGE LIFE		150C	1000	HRS	77	0		
WRITE CYCLE STRESS (KCYS)	0535	70 C, 3.6 VOLTS	10	KCYS	77	0		
STORAGE LIFE		150C	500	HRS	77	0		
WRITE CYCLE STRESS (KCYS)	0539	55 C, 5.5 VOLTS	30	KCYS	77	0		
STORAGE LIFE		150C	500	HRS	77	0		
WRITE CYCLE STRESS (KCYS)	0548	70 C, 5.5V (PSA) & 3.6V (PSB)	10	KCYS	77	0		
STORAGE LIFE		150C	96	HRS	77	0		
STORAGE LIFE	0549 *	150C	96	HRS	77	0		
WRITE CYCLE STRESS (KCYS)	*	85 C, 5.5 VOLTS	30	KCYS	77	0		
WRITE CYCLE STRESS (KCYS)	0552	70C, +5.5V (PSA), +5.5V (PSD)	10	KCYS	77	0		
STORAGE LIFE		150C	96	HRS	77	0		
			Total:		0			

FAILURE RATE: MTTF (YRS): 27278 FITS: 4.2